

AO4842 30V Dual N-Channel MOSFET

General Description

The AO4842 uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$ and low gate charge. The two MOSFETs make a compact and efficient switch and synchronous rectifier combination for use in buck converters.

Product Summary

 $V_{DS}(V) = 30V$

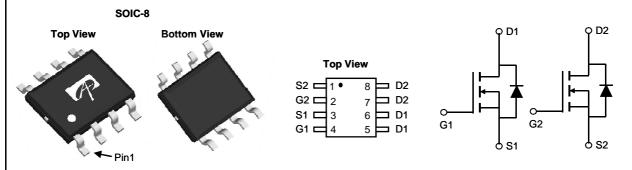
 $I_D = 7.7A$ $(V_{GS} = 10V)$

 $R_{DS(ON)} < 21m\Omega (V_{GS} = 10V)$

 $R_{DS(ON)} < 30 \text{m}\Omega \text{ (V}_{GS} = 4.5 \text{V)}$

100% UIS Tested 100% Rg Tested





Absolute Maximum Ratings T_A=25℃ unless otherwise noted

Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V_{GS}	±20	V	
Continuous Drain	T _A =25℃		7.7		
Current AF	T _A =70℃	I _D	6.5	Α	
Pulsed Drain Current ^B		I _{DM}	64		
	T _A =25℃	D	2	10/	
Power Dissipation	T _A =70℃	$-P_D$	1.44	W	
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	C	

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s	В	50	62.5	℃/W			
Maximum Junction-to-Ambient A	Steady-State	$R_{\theta JA}$	82	110	C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	41	50	℃/W			

Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units		
STATIC PARAMETERS									
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$		30			V		
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V			0.004	1	μА		
			T _J =55℃			5	μΑ		
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±20V				100	nA		
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=250\mu A$		1.5	2.1	2.6	V		
$I_{D(ON)}$	On state drain current	V_{GS} =4.5V, V_{DS} =5V		64			Α		
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =7.7A			16.8	21	mΩ		
		Т	_=125℃		24	29	11122		
		V_{GS} =4.5V, I_D =5A			23.4	30	mΩ		
g FS	Forward Transconductance	V_{DS} =5V, I_D =7.7A			20		S		
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V			0.75	1	V		
Is	Maximum Body-Diode Continuous Current					2.4	Α		
DYNAMIC	CPARAMETERS								
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz			373	448	pF		
C _{oss}	Output Capacitance				67		pF		
C_{rss}	Reverse Transfer Capacitance				41		pF		
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			1.8	2.8	Ω		
SWITCHI	NG PARAMETERS								
Q _g (10V)	Total Gate Charge	-V _{GS} =10V, V _{DS} =15V, I _D =7.7A			7.2	11	nC		
Q _g (4.5V)	Total Gate Charge				3.5		nC		
Q_{gs}	Gate Source Charge				1.3		nC		
Q_{gd}	Gate Drain Charge				1.7		nC		
t _{D(on)}	Turn-On DelayTime	V_{GS} =10V, V_{DS} =15V, R_L =1.95 Ω , R_{GEN} =3 Ω			4.5		ns		
t _r	Turn-On Rise Time				2.7		ns		
t _{D(off)}	Turn-Off DelayTime				14.9		ns		
t _f	Turn-Off Fall Time				2.9		ns		
t _{rr}	Body Diode Reverse Recovery Time	I _F =7.7A, dI/dt=100A/μs			10.5	12.6	ns		
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =7.7A, dI/dt=100A/μs			4.5		nC		

A: The value of R $_{\theta JA}$ is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ =25 $^\circ$ C. The value in any given application depends on the user's specific board design.

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B: Repetitive rating, pulse width limited by junction temperature.

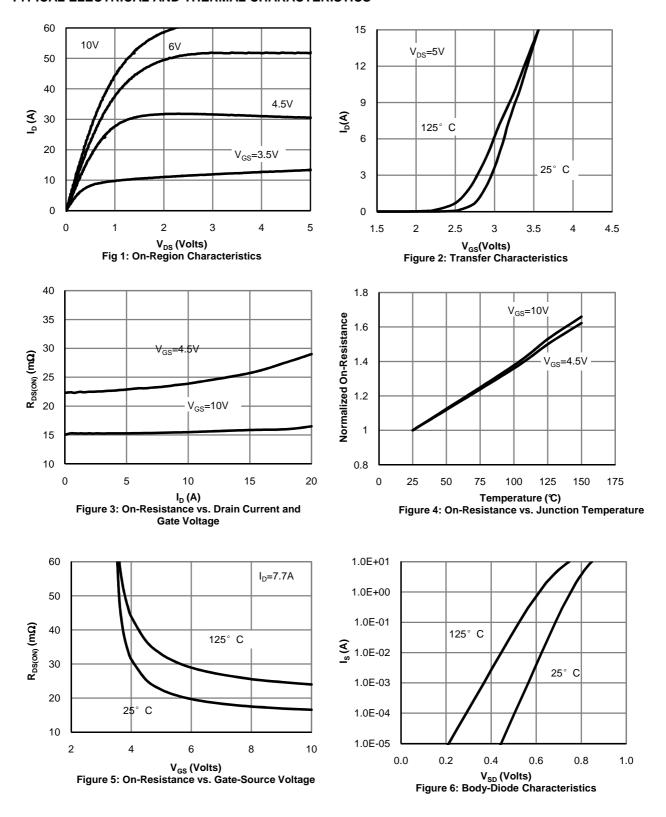
C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using <300 µs pulses, duty cycle 0.5% max.

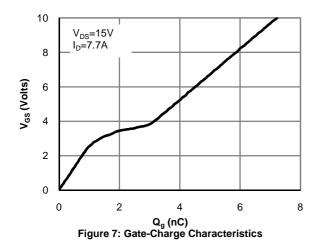
E. These tests are performed with the device mounted on 1 in ² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C. The SOA curve provides a single pulse rating.

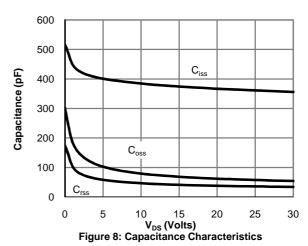
F. The current rating is based on the $t \le 10s$ thermal resistance rating.

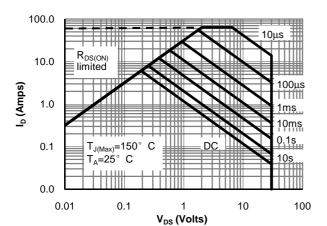
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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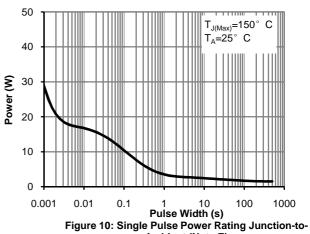
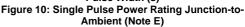


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)



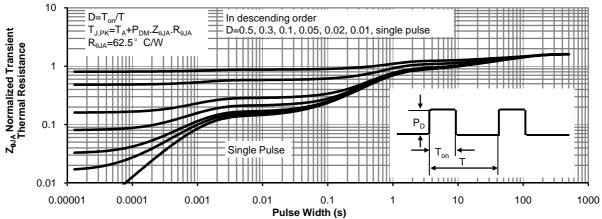


Figure 11: Normalized Maximum Transient Thermal Impedance